

Title (en)
PRINTED CIRCUIT BOARD

Title (de)
LEITERPLATTE

Title (fr)
CARTE DE CIRCUITS IMPRIMÉS

Publication
EP 2649864 A1 20131016 (DE)

Application
EP 11802853 A 20111207

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Abstract (en)
[origin: WO2012076166A1] The invention relates to a printed circuit board (1) having at least one rigid region (2) and at least one flexible region (3), having at least one rigid layer (6) laminated with copper (9) or provided with conductive tracks on one or both sides, and having at least one flexible layer (7) laminated with copper (9) or provided with conductive tracks on one or both sides, wherein the rigid layer (6) and the flexible layer (7) are connected to each other, wherein a rigid region of the printed circuit board (1) has at least one cut-out (12, 12', 12''), into which a molding (5) for dissipating heat losses is pressed.

IPC 8 full level
H05K 1/02 (2006.01); **H05K 3/40** (2006.01); **H05K 3/46** (2006.01); **H05K 7/20** (2006.01)

CPC (source: EP)
H05K 1/0204 (2013.01); **H05K 3/4691** (2013.01); **H05K 3/0047** (2013.01); **H05K 3/42** (2013.01); **H05K 2201/09854** (2013.01); **H05K 2201/10416** (2013.01); **H05K 2201/1059** (2013.01)

Citation (search report)
See references of WO 2012076166A1

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